

CATHODE (-) END VIEW



SIDE VIEW



ANODE (+) END VIEW



BOTTOM VIEW



Click [here](#) for the 3D model.

Dimensions

Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	4mm +/-0.3mm
T	0.13mm REF
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
A	3.8mm MIN
B	0.5mm +/-0.15mm
E	3.5mm REF
G	3.5mm REF
P	1.7mm REF
R	1mm REF
X	0.1mm +/-0.1mm

Packaging Specifications

Packaging	Waffle
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General Information

Series	T541 HRA
Dielectric	Polymer Tantalum
Style	SMD Chip
Description	SMD, Polymer, Molded, High Reliability, Multi-Anode, Low ESR
Features	Non-Combustible, Multiple Anode, Low ESR, High Reliability
RoHS	No
Prop 65	⚠ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov .
SCIP Number	b064b03e-bd75-42af-b342-1fe94dec2340
Termination	Solder Coated
Qualifications	DLA Drawing 04052
AEC-Q200	No
Component Weight	410.89 mg
Shelf Life	52 Weeks
MSL	3

Specifications

Capacitance	1,500 uF
Capacitance Tolerance	20%
Voltage DC	3 VDC (105C), 2.01 VDC (125C)
Temperature Range	-55/+125°C
Rated Temperature	105°C
Humidity	60C, 90% RH, 500 Hours, rated voltage
Dissipation Factor	10% 120Hz 25C
Failure Rate	N/A
Resistance	8 mOhms (100kHz 25C)
Ripple Current	5809 mA (rms, 100kHz 45C)
Leakage Current	450 uA (5min 25°C)
Testing and Reliability	10 Cycles Surge Current Testing At -55C +0C/-5C And +85C +/-5C After Voltage Aging

单击下面可查看定价，库存，交付和生命周期等信息

[>>KEMET\(基美\)](#)